ANALOG 11.07 GHz to 11.62 GHz, MMIC VCO with Half **DEVICES** Frequency Output

Data Sheet

FEATURES

Dual output frequency range f_{OUT} = 11.07 GHz to 11.62 GHz f_{OUT}/2 = 5.535 GHz to 5.810 GHz Output power (P_{OUT}): 8 dBm Single-sideband (SSB) phase noise: -113 dBc/Hz at 100 kHz No external resonator needed RoHS-compliant, 5 mm × 5 mm, 32-lead LFCSP: 25 mm²

APPLICATIONS

Point to point and multipoint radios Test equipment and industrial controls Very small aperture terminals (VSATs)

HMC1165

FUNCTIONAL BLOCK DIAGRAM



GENERAL DESCRIPTION

The HMC1165 is a monolithic microwave integrated circuit (MMIC), voltage controlled oscillator (VCO) that integrates a resonator, a negative resistance device, and a varactor diode, and features a half frequency output.

Because of the monolithic construction of the oscillator, the output power and phase noise performance are excellent over temperature. The output power is 8 dBm typical from a 5 V supply voltage. The VCO is housed in a RoHS-compliant LFCSP and requires no external matching components.

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REVISION HISTORY

10/15—Revision 0: Initial Version

SPECIFICATIONS

 $T_{\rm A}$ = $-40^{\rm o}C$ to +85°C, $V_{\rm CC}$ = 5 V, unless otherwise noted.

Table 1.

Parameter	Min	Тур	Мах	Unit	Test Conditions/Comments
FREQUENCY					
Range					
Output Frequency (fout)	11.07		11.62	GHz	
Half Output Frequency (f _{out} /2)	5.535		5.810	GHz	
Drift Rate		1.2		MHz/°C	
Pulling		0.35		MHz p-p	Pulling into a 2.0:1 voltage standing wave ratio (VSWR)
Pushing		10		MHz/V	At VTUNE = 5 V
OUTPUT POWER (POUT)					
RFOUT	4.5	8	11.5	dBm	
RFOUT/2	2	5	10	dBm	
Supply Current (Icc)		185		mA	$V_{CC} = 4.75 V$
	160	210	280	mA	$V_{CC} = 5.00 V$
		230		mA	$V_{CC} = 5.25 V$
HARMONICS, SUBHARMONICS					
1/2		35		dBc	
3/2		16		dBc	
Second		14		dBc	
Third		25		dBc	
TUNING					
Voltage (VTUNE)	2		13	V	
Sensitivity	70		310	MHz/V	
Tune Port Leakage Current			10	μA	VTUNE = 13 V
OUTPUT RETURN LOSS		4		dB	
SSB PHASE NOISE					
10 kHz Offset		-88	-82	dBc/Hz	
100 kHz Offset		-113	-109	dBc/Hz	

ABSOLUTE MAXIMUM RATINGS

Table 2.

14010 21			
Parameter	Rating		
Vcc	5.5 V dc		
VTUNE	0 V to 15 V		
Temperature			
Operating	–40°C to +85°C		
Storage	–65°C to +150°C		
Nominal Junction (to Maintain 1 Million	135°C		
Hours Mean Time to Failure (MTTF))			
Nominal Junction ($T_A = 85^{\circ}C$)	117°C		
Maximum Reflow Temperature (MSL3 Rating)	260°C		
Thermal Resistance (Junction to Ground	27.6°C/W		
Paddle)			
ESD Sensitivity (Human Body Model)	Class 1A		

Stresses at or above those listed under Absolute Maximum Ratings may cause permanent damage to the product. This is a stress rating only; functional operation of the product at these or any other conditions above those indicated in the operational section of this specification is not implied. Operation beyond the maximum operating conditions for extended periods may affect product reliability.

ESD CAUTION



ESD (electrostatic discharge) sensitive device. Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

PIN CONFIGURATION AND FUNCTION DESCRIPTIONS



Figure 2. Pin Configuration

13383-002

Table 3. Pin Function Descriptions

Pin No.	Mnemonic	Description
1 to 4, 6 to 10, 13 to 18, 20, 22 to 28, 30 to 32	NC	No Connect. However, these pins can be connected to RF/dc ground without affecting the performance of the device.
5, 11	GND	Ground. These pins must be connected to RF/dc ground.
12	RFOUT/2	Half Frequency Output. This pin is ac-coupled.
19	RFOUT	RF Output. This pin is ac-coupled.
21	Vcc	Supply Voltage (5 V).
29	VTUNE	Control Voltage and Modulation Input. The modulation bandwidth is dependent on the drive source impedance.
	EP	Exposed Pad. The package bottom has an exposed metal pad that must be connected to RF/dc ground.

HMC1165

INTERFACE SCHEMATICS

V_{cc} o-

42pF

Figure 5. V_{CC} Interface

13383-005



TYPICAL PERFORMANCE CHARACTERISTICS



Figure 8. Output Frequency vs. Tuning Voltage





Figure 10. Sensitivity vs. Tuning Voltage





Figure 12. RFOUT/2 Output Frequency vs. Tuning Voltage



Figure 13. RFOUT/2 Output Power vs. Tuning Voltage

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Figure 15. SSB Phase Noise vs. Offset Frequency at VTUNE = 5 V

APPLICATIONS INFORMATION

The HMC1165 serves as the local oscillator (LO) in microwave synthesizer applications. The primary applications are point to point microwave radios, military, radars, test and measurement, as well as industrial and medical equipment. The low phase noise allows higher orders of modulation and offers improved bit error rates in communication systems, whereas the linear,

monotonic tuning sensitivity allows a stable loop filter design. The higher output power minimizes the gain required to drive subsequent stages. The half frequency output reduces the input frequency to the prescaler without the addition of residual phase noise to the input of the phase-locked loop synthesizer.



Figure 16. Typical Application Diagram

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EVALUATION PRINTED CIRCUIT BOARD (PCB)



The circuit board used in an application uses RF circuit design techniques. Ensure that the signal lines have 50 Ω impedance and that the package ground leads and backside ground paddle are connected directly to the ground plane.

Use a sufficient number of via holes to connect the top and bottom ground planes. The evaluation circuit board shown in Figure 17 is available from Analog Devices, Inc., upon request.

BILL OF MATERIALS

Table 4	. Bill of Materials	EV1HMC1165LP5
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ltem	Description
J1 to J4	PCB mount SMA RF connectors
J5, J6	2 mm dc headers
C1 to C3	100 pF capacitors, 0402 package
C4	1000 pF capacitor, 0402 package
C5 to C7	2.2 μF tantalum capacitors
C8	0.01 μF capacitor, 0603 package
U1	HMC1165 VCO
PCB ¹	110225 evaluation board ²

¹ Circuit board material is Rogers 4350.

² Reference this number when ordering the complete evaluation PCB.

PACKAGING AND ORDERING INFORMATION OUTLINE DIMENSIONS



ORDERING GUIDE

Model ¹	Temperature Range	MSL Rating ²	Package Description	Package Option	Qty.	Brand ³
HMC1165LP5E	-40°C to +85°C	MSL3	32-Lead LFCSP_VQ	HCP-32-1		$\frac{\text{H1165}}{\text{XXXX}}$
HMC1165LP5ETR	-40°C to +85°C	MSL3	32-Lead LFCSP_VQ, 7" Tape and Reel	HCP-32-1	500	$\frac{H1165}{XXXX}$
EV1HMC1165LP5			Evaluation Board			

¹ The HMC1165LP5E and HMC1165LP5ETR are RoHS compliant parts.

² See the Absolute Maximum Ratings section, Table 2.

³ XXXX is a placeholder for the 4-digit lot number.

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